

**138—174 MHz RF ASSEMBLY 19D416693G1, G2, G7, G8
 AND MIXER/IF BOARD 19C320153G1**

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DESCRIPTION

The RF Assembly uses five tuned helical resonators to provide front end RF selectivity with no gain. A UHS pre-amplifier assembly is available that can be used with the receiver to improve sensitivity.

The Mixer/IF board (MIF) uses the RF signal from the RF Assembly and the mixer injection frequency from the oscillator multiplier board to generate the IF frequency.

through five high Q helical resonators that provide the front end RF selectivity. The helicals are tuned to the incoming frequency by C301 through C305.

MIXER-IF

MIXER & CRYSTAL FILTER

The mixer uses a FET (Q501) as the active device. The FET mixer provides a high input impedance, high power gain, and an output relatively free of harmonics (low in intermodulation products).

CIRCUIT ANALYSIS

RF ASSEMBLY

RF PRE-AMPLIFIER (Optional)

The pre-amplifier is present only in UHS receivers, and uses a dual-gate Field Effect Transistor (FET) to provide approximately 12 dB gain.

RF from the antenna is coupled through T2301 to Gate 1 of pre-amplifier Q2301. The primary of T2301 provides a 50 ohm input impedance. The amplified output at the drain terminal of Q2301 is coupled through T2302 and connected to J1 on Antenna Input board A301 through cable W2302. T2302 is tapped to provide a 50 ohm output impedance. P2301 connects to J501 on the MIF board for the regulated +10 Volt supply voltage.

ANTENNA INPUT A301/A301B

An RF signal from the antenna or UHS pre-amplifier is applied to A301 which provides an AC ground between vehicle ground and receiver A-. Resistor R1 prevents a static charge from building up on the vehicle antenna. The output of A301 is coupled

In the mixer stage, RF from the helical resonators is coupled through L502 and C502 which matches the RF output to the gate of mixer Q501. Injection voltage from the multiplier-selectivity stages is inductively coupled through L501 to the source of the mixer. The 11.2 MHz mixer IF output signal is coupled from the drain of Q501 through a tuned circuit (L505 and C505) which matches the mixer output to the input of the four-pole monolithic crystal filter. The highly-selective crystal filter (FL501 and FL502) provides the first portion of the receiver IF selectivity. The output of the filter is coupled through impedance-matching network L520 and C523 to the IF amplifier.

Service Note: Variable capacitor C521 does not require adjustment when performing normal alignment. If the four-pole monolithic crystal filter is replaced, then adjustment of C521 is necessary for optimum IF response.

IF AMPLIFIER

IF amplifier Q520 is a dual-gate FET. The filter output is applied to Gate 1 of the amplifier, and the output is taken from the drain. The biasing on Gate 2 and the drain load determines the gain of the stage. The amplifier provides approximately 20 dB of IF gain.

The output of Q520 is coupled through impedance matching network L521, and C528 and coupling capacitor C529 and feed-through capacitor C325 to the next IF stage on to the MIF switch in Dual Front End Applications.

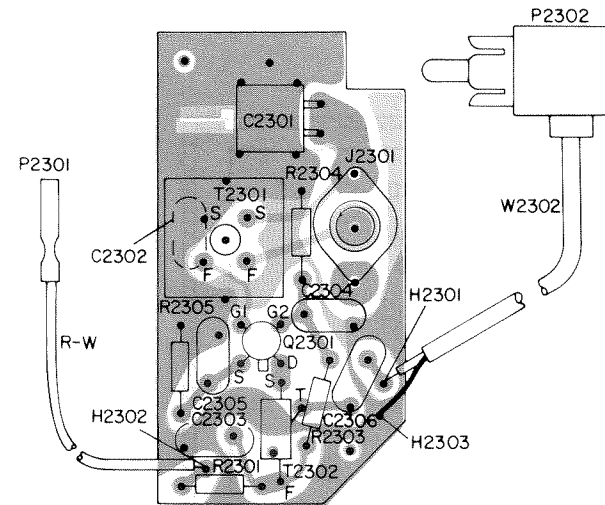
Supply voltage for the RF amplifier and MIF board is supplied through feed-through capacitor C326.

GENERAL ELECTRIC COMPANY • MOBILE COMMUNICATIONS DIVISION
WORLD HEADQUARTERS • LYNCHBURG, VIRGINIA 24502 U.S.A.



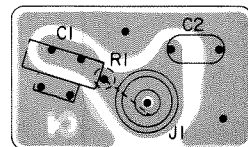
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UHS PRE-AMPLIFIER



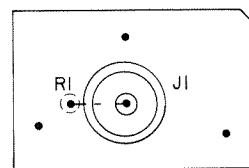
(19C320201, Sh. 2, Rev. 1)
(19C320201, Sh. 3, Rev. 1)

A301A
ANT INPUT
(FLOATING GROUND)

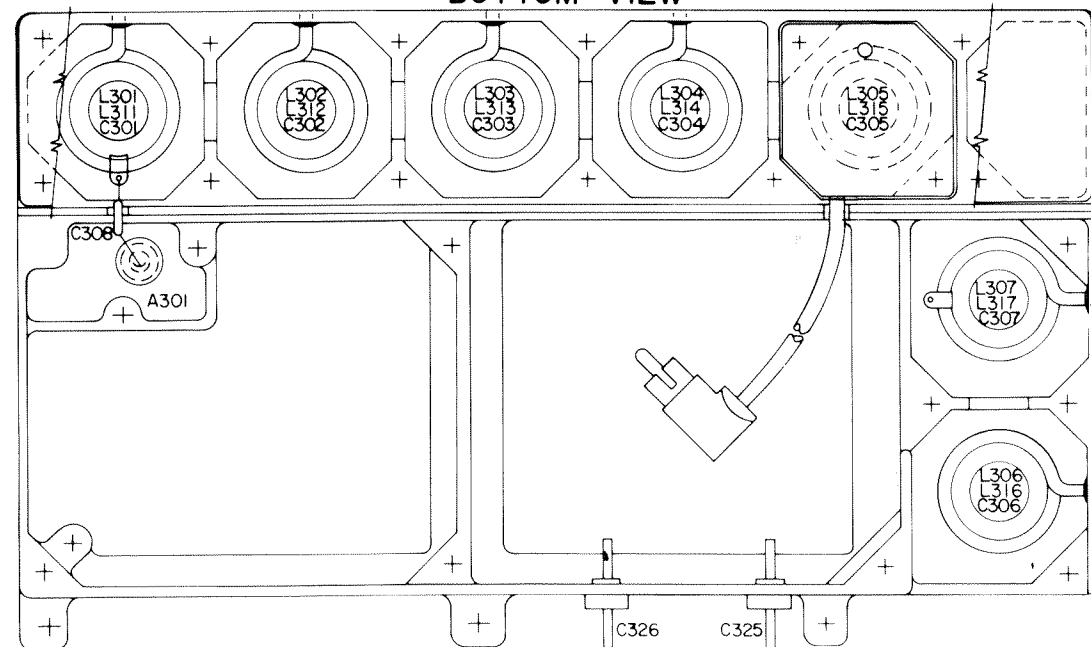


(19B219679, Sh. 2, Rev. 2)
(19B219679, Sh. 3, Rev. 2)

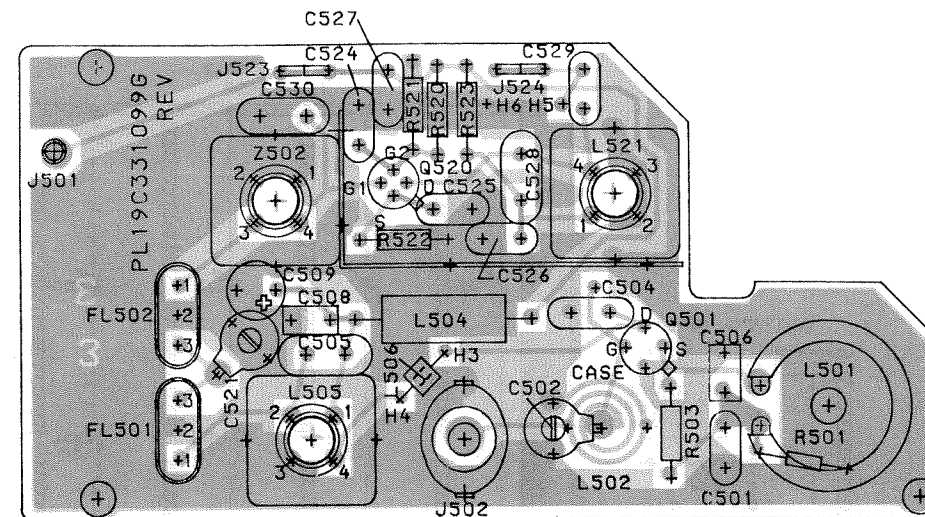
A301B
ANT INPUT
(NON-FLOATING GROUND)



RF ASSEMBLY
BOTTOM VIEW



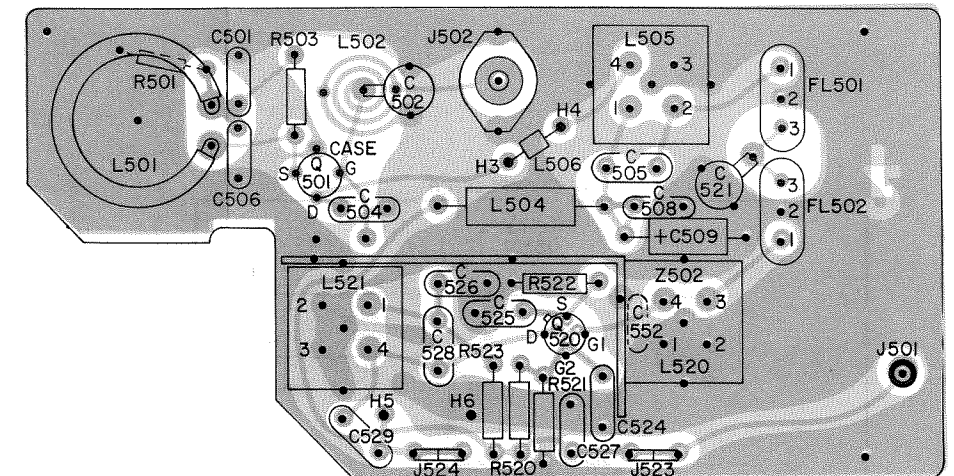
MIXER/ IF BOARD 19C331099G1



(19C331175, Rev. 3)
(19A143701, Sh. 1, Rev. 3)
(19A143701, Sh. 2, Rev. 3)

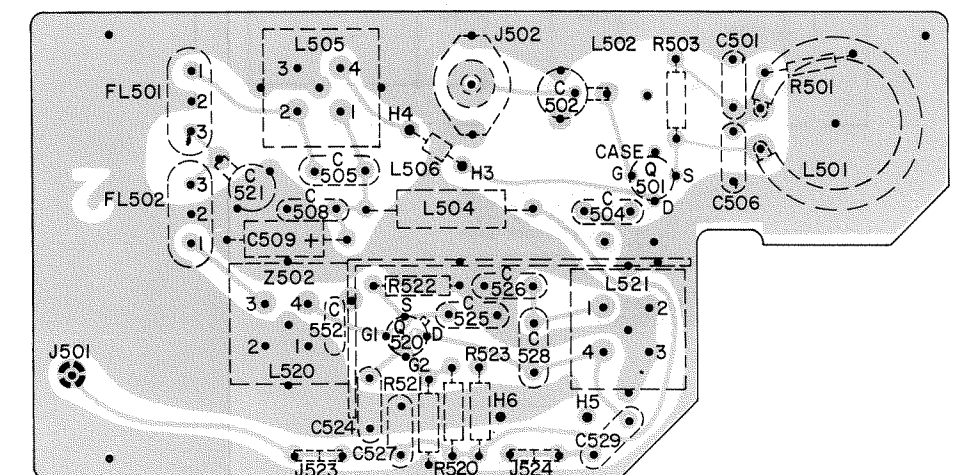
MIXER/ IF BOARD 19C320153G1

COMPONENT SIDE



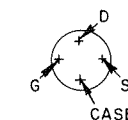
(19C321054, Sh. 2, Rev. 2)
(19C321054, Sh. 3, Rev. 1)

SOLDER SIDE



(19C321054, Sh. 2, Rev. 3)

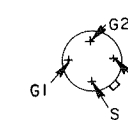
LEAD IDENTIFICATION
FOR Q501



VIEW FROM CASE END

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

Q520, Q2301



OUTLINE DIAGRAM

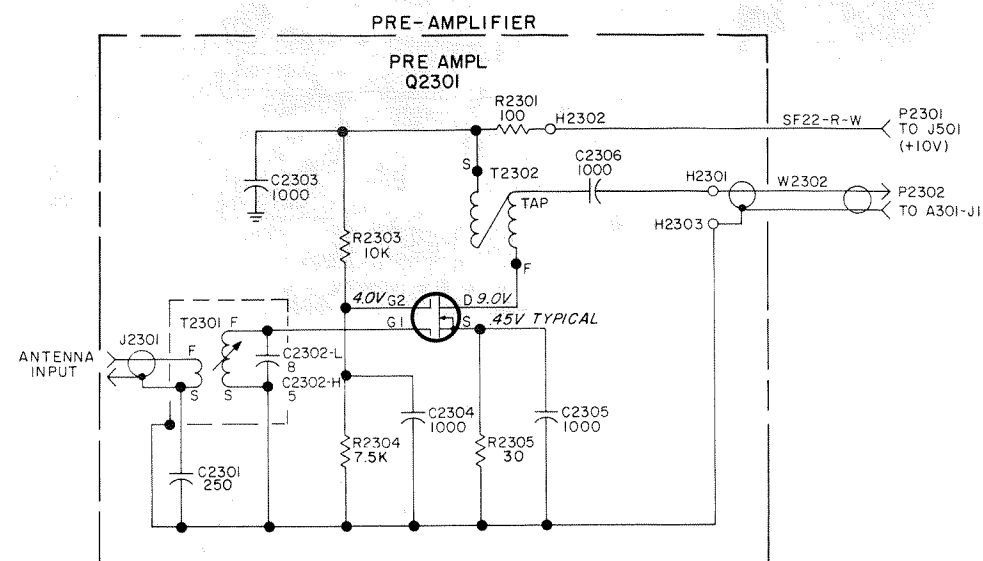
138—174 MHz RF ASSEMBLY
AND MIXER/IF BOARD

Issue 4

3

Diagram illustrating three types of solder joints:

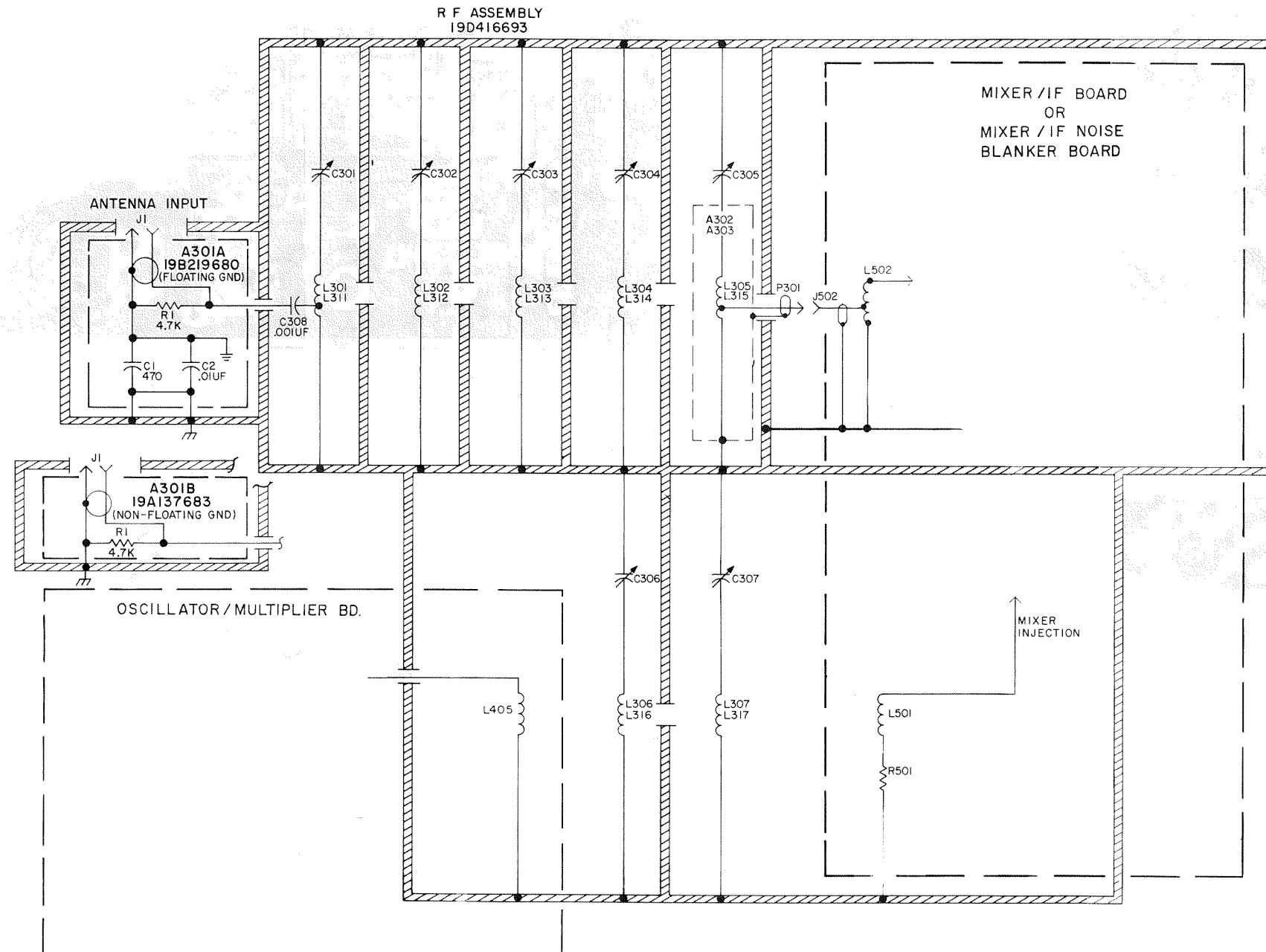
- RUNS ON SOLDER SIDE**: The solder is applied to the solder side of the PCB.
- RUNS ON BOTH SIDES**: The solder is applied to both sides of the PCB.
- RUNS ON COMPONENT SIDE**: The solder is applied to the component side of the PCB.



SEE APPLICABLE PRODUCTION CHANGE
SHEETS IN INSTRUCTION BOOK SECTION
DEALING WITH THIS UNIT, FOR DES-
SCRIPTION OF CHANGES UNDER EACH
REVISION LETTER

MODE NO	REV LETTER
PLI9C3202I5G1	B
PLI9C3202I5G2	B

(19B219622, Rev. 5)



ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG=1,000,000 OHMS. CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF= MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H=HENRYS.

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

VOLTAGE READINGS

VOLTAGE READINGS ARE TYPICAL READINGS
MEASURED TO SYSTEM NEGATIVE (P903-10)
WITH TEST SET MODEL 4EX3A11 OR A 20,000
OHM-PER-VOLT METER.

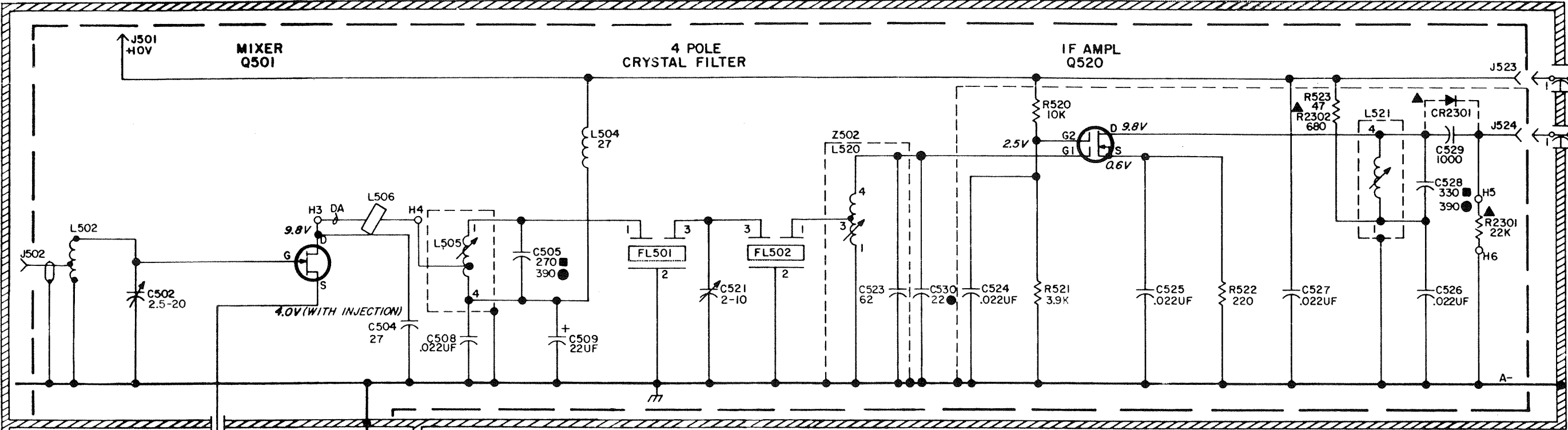
INDICATES A-

⊥ INDICATES VEHICLE GROUND

SCHEMATIC DIAGRAM

138—174 MHz RF ASSEMBLY

MIXER/IF BD
19C320153 / 19C331099



C326 .001UF
REG 10V FROM J623
▲ (FOR DFE, FROM J2303 ON MIF SWITCH)
C325 6.8
IF OUT TO J624
▲ (FOR DFE, TO J2302 ON MIF SWITCH)

■ G1, 11.2 MHz IF, ONLY	
● G2, 9.4 MHz IF ONLY	
▲ THESE COMPONENTS ARE USED TO ADAPT A STANDARD MASTR II RECEIVER TO OPERATION AS AND WITH A DUAL FRONT END. THESE COMPONENTS SHOULD BE IGNORED IN THE STANDARD RECEIVER. BOARDS IDENTIFIED BY A RED DOT HAVE BEEN MODIFIED FOR DFE OPERATION PER MOD KIT 19A129750G1 OR G2.	
RECEIVER CHANNEL	DFE CHANNEL
ON PL19C320153 (MIXER/IF BD) ON PL19C331099 (MIXER/IF BD)	ON PL19C320153 (MIXER/IF BD) ON PL19C331099 (MIXER/IF BD)
1. R2302 USED INSTEAD OF R523 2. CR2301 USED INSTEAD OF C529 3. R2301 ADDED BETWEEN H5 & H6	NO MODIFICATION REQUIRED
THESE ITEMS ARE SUPPLIED IN MOD. KIT PL19A129750G1	SEE OSC/MULT BD. FOR OTHER DFE CHANGE
	THESE ITEMS ARE SUPPLIED IN MOD. KIT PL19A129750G2.

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG=1,000,000 OHMS CAPACITOR VALUES IN PICO FARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF= MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H=HENRYS.

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

VOLTAGE READINGS

VOLTAGE READINGS ARE TYPICAL READINGS MEASURED TO SYSTEM NEGATIVE (P903-10) WITH TEST SET MODEL 4EX3A11 OR A 20,000 OHM-PER-VOLT METER.

⏏ INDICATES A-
⏏ INDICATES VEHICLE GROUND

	REV LETTER	FREQ RANGE (MHZ)
MIXER/IF BD		
19C320153G1	C	138-174
19C331099		138-174

SCHEMATIC DIAGRAM

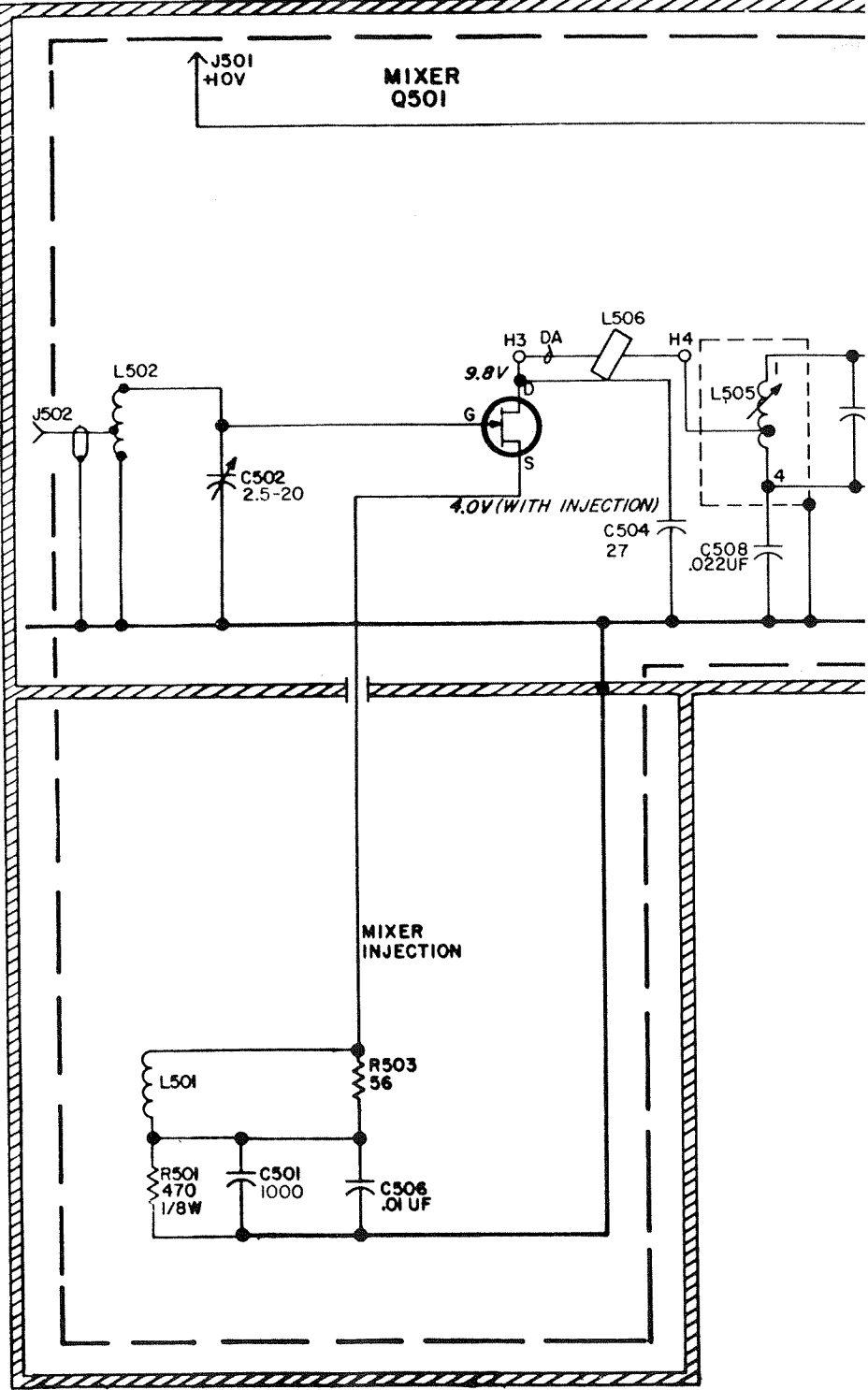
138—174 MHz MIXER/IF BOARD

PARTS LIST

MIF ASSEMBLY
19C331099G1
ISSUE 1

SYMBOL	GE PART NO.	DESCRIPTION
----- CAPACITORS -----		
C501	19A700233P7	Ceramic: 1000 pF, $\pm 20\%$, 50 VDCW.
C502	19A700012P2	Variable, ceramic: 2.5 to 20 pF, 200 VDCW, temp coef -250 to -700 Parts/M $^{\circ}$ C; sim to Panasonic ECV-12W20A32.
C504	19A143491P27K0	Ceramic: 27 pF, $\pm 10\%$, 500 VDCW.
C505	19A700105P46	Mica: 270 pF, $\pm 5\%$, 0 to 70 PPM, 500 VDCW.
C506	19A700234P7	Polyester: 0.01 μ F $\pm 10\%$, 50 VDCW.
C508	19A700234P9	Polyester: 0.022 μ F, $\pm 10\%$, 50 VDCW.
C509	19A701534P8	Tantalum: 22 μ F, $\pm 20\%$, 16 VDCW.
C521	19A700012P1	Variable, ceramic: 2 to 10 pF, 200 VDCW, temp coef -350 to +500 PPM Parts/M $^{\circ}$ C; sim to Panasonic ECV-12W10A32.
C524 thru C527	19A143477P17	Polyester: 0.022 μ F, $\pm 20\%$, 50 VDCW.
C528	5490008P139	330 pF $\pm 10\%$, 500 VDCW; sim to Electro Motive Type DM-15.
C529	19A700233P7	Ceramic, disc: 1000 pF $\pm 20\%$, 50 VDCW.
----- FILTERS -----		
FL501	19B219573G7	Crystal, freq: Resonator A: 11,200000 KHz, Resonator B: 11,196024 KHz, Resonator A: 11,200000 KHz, Resonator B: 11,196024 KHz.
FL502		(Part of FL501).
----- JACKS AND RECEPTACLES -----		
J501	4033513P1	Contact, electrical: sim to Bead Chain L93-1.
J502	19A130924G1	Receptacle, coaxial: sim to Cinch 14H11613.
J523 and J524	19A116975P1	Receptacle, wire spring.
----- INDUCTORS -----		
L501	19A129280P1	Coil.
L502		Coil. (Part of printed wire board 19C331098P1).
L504	7488079P48	Choke, RF: 27.0 μ H $\pm 10\%$, 1.40 ohms DC res max; sim to Jeffers 4422-9K.
L505	19C320141G30 5493185P9	Coil. Includes: Tuning slug.
L506	19A126140P1	Core, toroidal.
L520		(Part of Z502).
L521	19C320141G6 5493185P9	Coil. Includes: Tuning slug.
----- TRANSISTORS -----		
Q501	19A134093P1	N Type, field effect; sim to Type 2N4391.
Q520	19A116818P1	N Channel, field effect; sim to Type 3N187.
----- RESISTORS -----		
R501	3R151P471J	Composition: 470 ohms $\pm 5\%$, 1/8 w.
R503	19A700106P33	Composition: 56 ohms $\pm 10\%$, 1/4 w.

SYMBOL	GE PART NO.	DESCRIPTION
R520	19A700106P87	Composition: 10K ohms $\pm 10\%$, 1/4 w.
R521	19A700106P77	Composition: 3.9K ohms $\pm 5\%$, 1/4 w.
R522	19A700106P47	Composition: 220 ohms $\pm 5\%$, 1/4 w.
R523	19A700106P31	Composition: 47 ohms $\pm 5\%$, 1/4 w.
		----- NETWORKS -----
Z502		COIL ASSEMBLY 19C320141G20
		----- CAPACITORS -----
C523	19A116114P1057	Ceramic: 62 pF $\pm 5\%$, 100 VDCW; temp coef -30 PPM.
		----- INDUCTORS -----
L520	19C320141P4 5493185P9	Coil. Tuning slug.



*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

PARTS LIST

LBI4981E
138-174 MHz RF ASSEMBLY
MIF ASSEMBLY,
UHS PRE-AMPLIFIER

SYMBOL	GE PART NO.	DESCRIPTION
A301A		RF ASSEMBLY 19D416693G1 138-155 MHz FLOATING GRD 19D416693G2 150.8-184 MHz FLOATING GRD 19D416693G7 138-155 MHz NON FLOATING GRD 19D416693G8 150.8-174 MHz NON FLOATING GRD
		ANTENNA INPUT BOARD 19B219680G1
		----- CAPACITORS -----
		C1 19A116679P470K Mica: 470 pF $\pm 10\%$, 250 VDCW.
C2	19A116080P101	Polyester: 0.01 uF $\pm 10\%$, 50 VDCW.
J1	7104941P16	----- JACKS AND RECEPTACLES -----
		Jack, phono: coaxial.
R1	19A700106P79	----- RESISTORS -----
		Composition: 4.7K ohms $\pm 5\%$, 1/4 w.
A301B		ANTENNA INPUT PLATE 19A137683G1
J1	7104941P20	----- JACKS AND RECEPTACLES -----
		Jack, phono: coaxial.
R1	19A700106P79	----- RESISTORS ----- Composition: 4.7K ohms $\pm 5\%$, 1/4 w.
A302 and A303		COMPONENT BOARD A302 19B226512G1 138-155 MHz A303 19B226512G2 150.8-174 MHz
L305	19B216112G20	----- INDUCTORS -----
		Coil.
L315	19B216112G21	Coil.
P301	5491689P85	----- CABLES -----
		Cable, RF: approx 4 inches long.
C301 thru C305		----- CAPACITORS -----
		Includes:
C306* and C307*		19C328755P3 Screw.
		19A143476G2 Nut: thd. size No. 6-32.
		Includes:
		19C328755P3 Screw. (Added to G2 by REV C).
C308	5495581P11	4036765G12 Screw. (Deleted in G2 by REV C).
		19A143476G2 Nut: thd. size No. 6-32.
C325	19B209488P1	Ceramic disc: 1000 pF $\pm 20\%$, 1000 VDCW; sim to RMC Type JR Discap.
C326	19B209488P2	Ceramic: 6.8 pF $\pm 20\%$, 500 VDCW; sim to Allen Bradley Style FA5D.
L301	19B216112G19	----- INDUCTORS -----
		Coil.
L302 thru L304	19B216112G11	Coil.

SYMBOL	GE PART NO.	DESCRIPTION
L306 and L307	19B204461G18	Coil.
L311	19B216112G17	Coil.
L312 thru L314	19B216112G15	Coil.
L316 and L317	19B204461G19	Coil.
		----- MISCELLANEOUS -----
		19E500969G1 Casting.
		19C320251P1 Cover.
		19B209209P305 Tap screw, Phillips POZIDRIV®: No. 6-32 x 5/16. (Secures cover).
	19B201074P304	Tap screw, Phillips POZIDRIV®: No. 6-32 x 1/4. (Used with A301-A303).
		MIF ASSEMBLY 19C320153G1
C501	19A116655P19	----- CAPACITORS -----
		Ceramic disc: 1000 pF $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.
C502	19A700012P2	Variable, ceramic: 2.5 to 20 pF 200 VDCW, temp coef -250 -700 PPM; sim to Panasonic ECX1ZW20X32.
C504	19A116656P27K0	Ceramic disc: 27 pF $\pm 10\%$, 500 VDCW, temp coef 0 PPM.
C505	19A700105P46	Mica: 270 pF $\pm 5\%$, 500 VDCW.
C506	19A116080P101	Polyester: 0.01 uF $\pm 10\%$, 50 VDCW.
C508	19A116080P103	Polyester: 0.022 uF $\pm 10\%$, 50 VDCW.
C509	5496267P10	Tantalum: 22 uF $\pm 20\%$, 15 VDCW; sim to Sprague Type 150D.
C521	19A700012P1	Variable, ceramic: 2 to 10 pF, 200 VDCW, temp coef -350 to +500 PPM; sim to Panasonic ECV-1ZW10X32.
C523		(Part of Z502).
C524 thru C527	19A116080P3	Polyester: 0.022 uF $\pm 20\%$, 50 VDCW.
C528	5490008P139	Silver mica: 330 pF $\pm 10\%$, 500 VDCW, sim to Electro Motive Type DM-15.
C529	19A116655P19	Ceramic disc: 1000 pF $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.
FL501	19B219573G3	----- FILTERS -----
		Crystal: Resonator A - 11,200.000; Resonator B - 11,196.024 kHz.
FL502		(Part of FL501).
J501	4033513P1	----- JACKS AND RECEPTACLES -----
		Contact, electrical: sim to Bead Chain L93-4.
J502	19A700049P2	Connector, receptacle; 500 VDCW maximum; sim to NTTF-1058.
J523 and J524	19A116975P1	Contact, electrical.
L501	19A129280P1	----- INDUCTORS -----
		Coil.
L502		Coil. (Part of printed wire board 19C321054P1)
L504	7488079P48	Coil, RF: 27 uH 10%, 1.4 ohms DC res. max; sim. to Jeffers 4422-9.
L505	19C320141G30	Coil. Includes:
L506	5493185P9	Tuning slug.
		Core toroidal, ferrite: sim to Ferrocube 56-590-65A1/20.
L520		(Part of Z502).
L521	19C320141G6	Coil. Includes:
	5493185P9	Tuning slug.

SYMBOL	GE PART NO.	DESCRIPTION
Q501	19A134093P1	----- TRANSISTORS -----
		N Type, field effect; sim to Type 2N4391.
Q520	19A116818P1	N Channel, field effect.
R501	3R151P471J	----- RESISTORS -----
		Composition: 470 ohms $\pm 5\%$, 1/8 w.
R503	19A700106P33	Composition: 56 ohms $\pm 5\%$, 1/4 w.
R520	19A700106P87	Composition: 10K ohms $\pm 5\%$, 1/4 w.
R521	19A700106P77	Composition: 3.9K ohms $\pm 5\%$, 1/4 w.
R522	19A700106P47	Composition: 220 ohms $\pm 5\%$, 1/4 w.
R523	19A700106P31	Composition: 47 ohms $\pm 5\%$, 1/4 w.
Z502		----- NETWORKS -----
		COIL ASSEMBLY 19C320141G20
C523	19A700220P57	----- CAPACITORS -----
		Ceramic: 62 pF $\pm 5\%$, 100 VDCW, temp coef -30 PPM.
L520	19C320141P4	----- INDUCTORS -----
		Coil.
	19B209674P2	Tuning slug.
C2301	19A116795P250K	UHS PRE-AMPLIFIER BOARD 19C320215G1 138-158 MHz 19C320215G2 147-174 MHz
		----- CAPACITORS -----
		Mica: 250 pF $\pm 10\%$, 250 VDCW.
		(Part of T2301L).
C2302L		(Part of T2301H).
C2302H		(Part of T2301H).
C2303 thru C2306	19A116655P19	Ceramic disc: 1000 pF $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.
J2301	19A700049P2	----- JACKS AND RECEPTACLES -----
		Connector, receptacle; 500 VDCW maximum; sim to NTTF-1058.
P2301	19A702402P2	----- PLUGS -----
P2302		Contact, electrical; sim to AMP 42827-2. (Part of W2302).
Q2301	19A116818P1	----- TRANSISTORS -----
		N Channel, field effect.
R2301	19A700106P39	----- RESISTORS -----
		Composition: 100 ohms $\pm 5\%$, 1/4 w.
R2303	19A700106P87	Composition: 10K ohms $\pm 5\%$, 1/4 w.
R2304	3R152P752J	Composition: 7.5K ohms $\pm 5\%$, 1/4 w.
R2305	3R152P300J	Composition: 30 ohms $\pm 5\%$, 1/4 w.
T2301L		----- TRANSFORMERS -----
		COIL ASSEMBLY 19C320141G22
C4	5496218P308	----- CAPACITORS -----
		Ceramic disc: 8 pF $\pm 10\%$, 500 VDCW, temp coef -150 PPM.
L1	19C320141P25	----- INDUCTORS -----
		Coil.
	19B209674P2	Tuning slug.

SYMBOL	GE PART NO.	DESCRIPTION
T2301H		COIL ASSEMBLY 19C320141G21
C5	5496218P305	----- CAPACITORS -----
		Ceramic disc: 5.0 pF $\pm 10\%$, 500 VDCW, temp coef -150 PPM.
L1	19C320141P25	----- INDUCTORS -----
		Coil.
	19B209674P2	Tuning slug.
T2302	19A127108G1	Coil.
W2302	5491689P85	----- CABLES -----
		Cable, RF: approx 4 inches long. (Includes P2302).
		----- MISCELLANEOUS -----
		19B219470P2 Shield.
		19A129424G1 Can. (Used with L505, L521, Z502 and T2301 on PRE-AMPLIFIER Board).
		4031594P1 Insulator. (Located under C502, C521).
	4035306P23	Washer, fiber. (Located under J502).
	4035306P11	Washer, fiber: 1/8 dia. (Located under Q520).
CR2301	19A116925P1	RECEIVER MODIFICATION KIT 19A129750G1
		----- DIODES AND RECTIFIERS -----
R2301	19A700106P95	Silicon.
		----- RESISTORS -----
R2302	19A700106P59	Composition: 22K ohms $\pm 5\%$, 1/4 w.
		Composition: 680 ohms $\pm 5\%$, 1/4 w.
W2301	19B219999G2	----- CABLES -----
		Cable, RF: approx 1 foot long. Includes: (1) 5496078P2 connector.
		DFE MODIFICATION KIT 19A129750G2

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

DESCRIPTION
oil.
oil.
oil.
oil.
----- MISCELLANEOUS -----
isting.
over.
ip screw, Phillips POZIDRIV®: No. 6-32 x 5/16. Secures cover).
ip screw, Phillips POZIDRIV®: No. 6-32 x 1/4. Used with A301-A303).
MIF ASSEMBLY 19C320153G1
----- CAPACITORS -----
ramic disc: 1000 pF ±20%, 1000 VDCW; sim to IC Type JF Discap.
riable, ceramic: 2.5 to 20 pF 200 VDCW, temp coef -250 -700 PPM; sim to Panasonic ECX1ZW20X32.
ramic disc: 27 pF ±10%, 500 VDCW, temp coef PPM.
.ca: 270 pF ±5%, 500 VDCW.
polyester: 0.01 uF ±10%, 50 VDCW.
polyester: 0.022 uF ±10%, 50 VDCW.
ntalum: 22 uF ±20%, 15 VDCW; sim to Sprague pe 150D.
riable, ceramic: 2 to 10 pF, 200 VDCW, temp coef -350 to +500 PPM; sim to Panasonic V-1ZW10X32.
art of Z502).
polyester: 0.022 uF ±20%, 50 VDCW.
lver mica: 330 pF ±10%, 500 VDCW, sim to ectro Motive Type DM-15.
ramic disc: 1000 pF ±20%, 1000 VDCW; sim to IC Type JF Discap.
----- FILTERS -----
ystal: Resonator A - 11,200.000; sonator B - 11,196.024 kHz.
art of FL501).
----- JACKS AND RECEPTACLES -----
ntact, electrical: sim to Bead Chain L93-4.
nnector, receptacle; 500 VDCW maximum; sim to TF-1058.
ntact, electrical.
----- INDUCTORS -----
il.
il. (Part of printed wire board 19C321054P1)
il, RF: 27 uH 10%, 1.4 ohms DC res. max; sim. Jeffers 4422-9.
il. Includes:
ning slug.
re toroidal, ferrite: sim to Ferrocube -590-65A1/20.
art of Z502).
il. Includes:
ning slug.

SYMBOL	GE PART NO.	DESCRIPTION
		----- TRANSISTORS -----
Q501	19A134093P1	N Type, field effect; sim to Type 2N4391.
Q520	19A116818P1	N Channel, field effect.
		----- RESISTORS -----
R501	3R151P471J	Composition: 470 ohms ±5%, 1/8 w.
R503	19A700106P33	Composition: 56 ohms ±5%, 1/4 w.
R520	19A700106P87	Composition: 10K ohms ±5%, 1/4 w.
R521	19A700106P77	Composition: 3.9K ohms ±5%, 1/4 w.
R522	19A700106P47	Composition: 220 ohms ±5%, 1/4 w.
R523	19A700106P31	Composition: 47 ohms ±5%, 1/4 w.
		----- NETWORKS -----
Z502		COIL ASSEMBLY 19C320141G20
		----- CAPACITORS -----
C523	19A700220P57	Ceramic: 62 pF ±5%, 100 VDCW, temp coef -30 PPM.
		----- INDUCTORS -----
L520	19C320141P4 19B209674P2	Coil. Tuning slug.
		UHS PRE-AMPLIFIER BOARD 19C320215G1 138-158 MHz 19C320215G2 147-174 MHz
C2301	19A116795P250K	Mica: 250 pF ±10%, 250 VDCW.
C2302L		(Part of T2301L).
C2302H		(Part of T2301H).
C2303 thru C2306	19A116655P19	Ceramic disc: 1000 pF ±20%, 1000 VDCW; sim to RMC Type JF Discap.
J2301	19A700049P2	----- JACKS AND RECEPTACLES ----- Connector, receptacle; 500 VDCW maximum; sim to NTTF-1058.
P2301	19A702402P2	----- PLUGS ----- Contact, electrical; sim to AMP 42827-2.
P2302		(Part of W2302).
Q2301	19A116818P1	----- TRANSISTORS ----- N Channel, field effect.
		----- RESISTORS -----
R2301	19A700106P39	Composition: 100 ohms ±5%, 1/4 w.
R2303	19A700106P87	Composition: 10K ohms ±5%, 1/4 w.
R2304	3R152P752J	Composition: 7.5K ohms ±5%, 1/4 w.
R2305	3R152P300J	Composition: 30 ohms ±5%, 1/4 w.
		----- TRANSFORMERS -----
T2301L		COIL ASSEMBLY 19C320141G22
		----- CAPACITORS -----
C4	5496218P308	Ceramic disc: 8 pF ±10%, 500 VDCW, temp coef -150 PPM.
		----- INDUCTORS -----
L1	19C320141P25 19B209674P2	Coil. Tuning slug.

SYMBOL	GE PART NO.	DESCRIPTION
T2301H		COIL ASSEMBLY 19C320141G21
		----- CAPACITORS -----
C5	5496218P305	Ceramic disc: 5.0 pF ±10%, 500 VDCW, temp coef -150 PPM.
		----- INDUCTORS -----
L1	19C320141P25 19B209674P2	Coil. Tuning slug.
T2302	19A127108G1	Coil.
		----- CABLES -----
W2302	5491689P85	Cable, RF: approx 4 inches long. (Includes P2302).
		----- MISCELLANEOUS -----
	19B219470P2 19A129424G1	Shield. Can. (Used with L505, L521, Z502 and T2301 on PRE-AMPLIFIER Board).
	4031594P1 4035306P23 4035306P11	Insulator. (Located under C502, C521). Washer, fiber. (Located under J502). Washer, fiber: 1/8 dia. (Located under Q520).
		RECEIVER MODIFICATION KIT 19A129750G1
		----- DIODES AND RECTIFIERS -----
CR2301	19A116925P1	Silicon.
		----- RESISTORS -----
R2301	19A700106P95	Composition: 22K ohms ±5%, 1/4 w.
R2302	19A700106P59	Composition: 680 ohms ±5%, 1/4 w.
		----- CABLES -----
W2301	19B219999G2	Cable, RF: approx 1 foot long. Includes: (1) 5496078P2 connector.
		DPE MODIFICATION KIT 19A129750G2

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

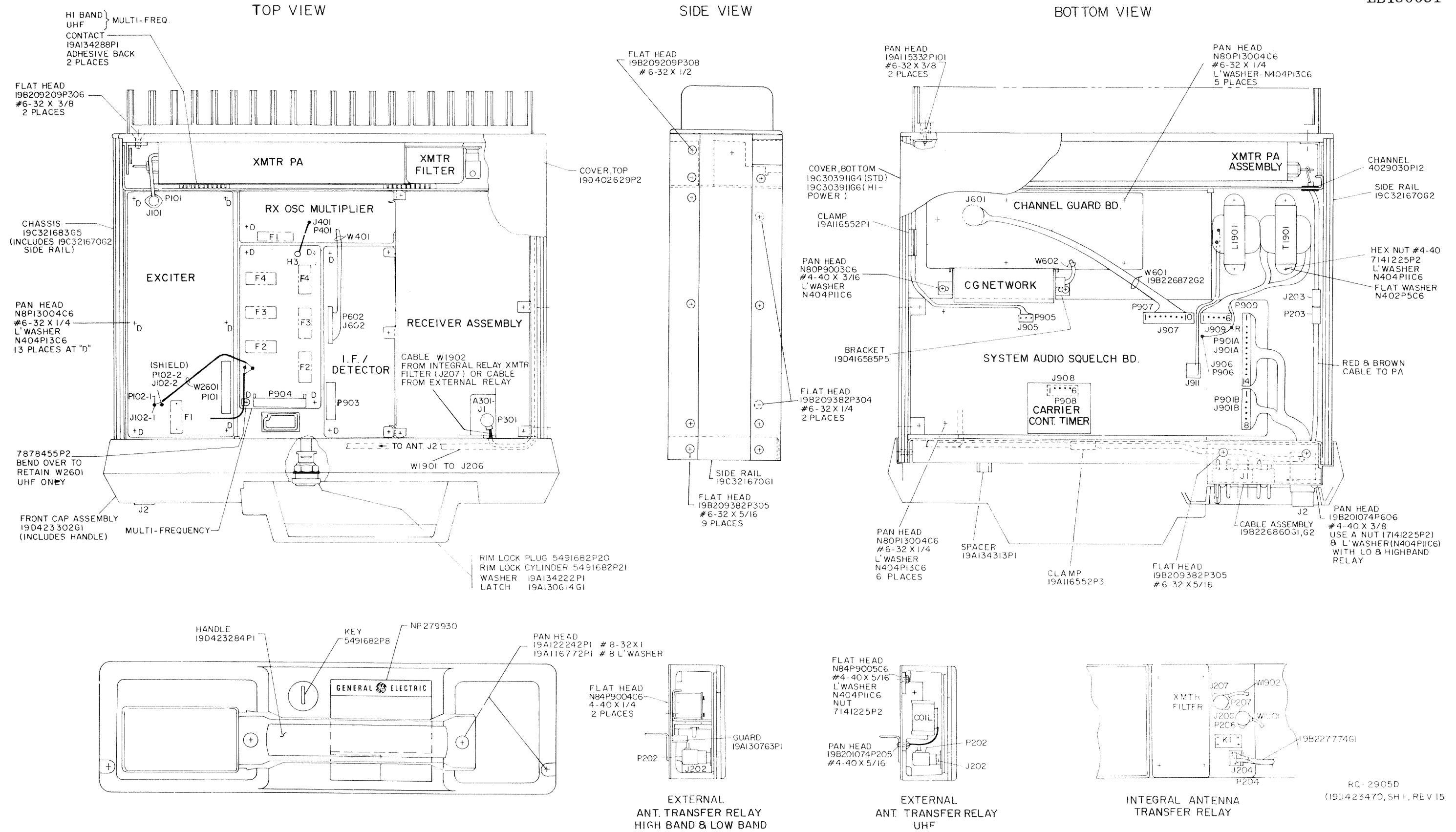
REV. A thru C - Mixer/IF Board 19C320153G1

REV. A and B - RF Assembly 19D416693G1,2

REV. A and B - Preamplifier Assembly 19C320215G1,2

Incorporated in initial shipment.

REV. C - RF Assembly 19D416693G2
To improve band end tuning. Changed C306 and C307.



MECHANICAL PARTS BREAKDOWN

MAIN CHASSIS